

# Product Change Notification

**Change Notification #:** 118619-02  
**Change Title:** Intel® Server System R2312WF0NPR,  
2U 12x3.5inch SAS  
PCN 118619-01, Product Design,  
Update Balun, labels  
[Reason for Revision: Updating Change  
Description and Products Affected table](#)  
**Date of Publication:** December 13, 2021

**Key Characteristics of the Change:**  
Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material*</b>	November 23, 2021
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

## Description of Change to the Customer:

[Reason for Revision: Updating Change Description and Products Affected table](#)

Intel is implementing the following changes to the items in table products affected below.

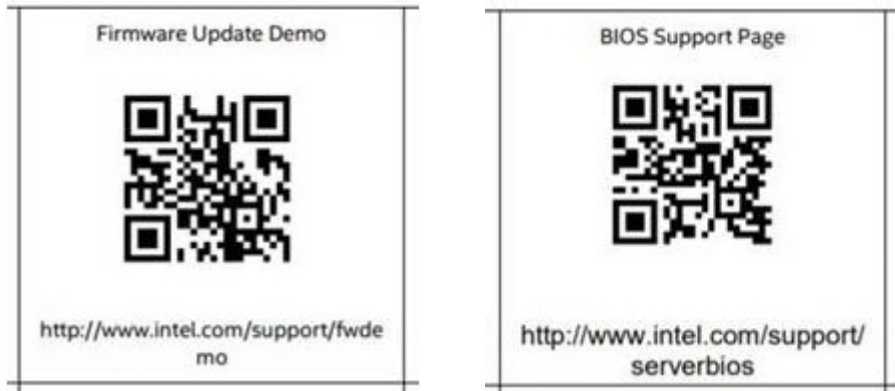
1. Removing a balun component located in L5K1 on boards  
PBA Before: H87179-951



PBA After: H87179-961



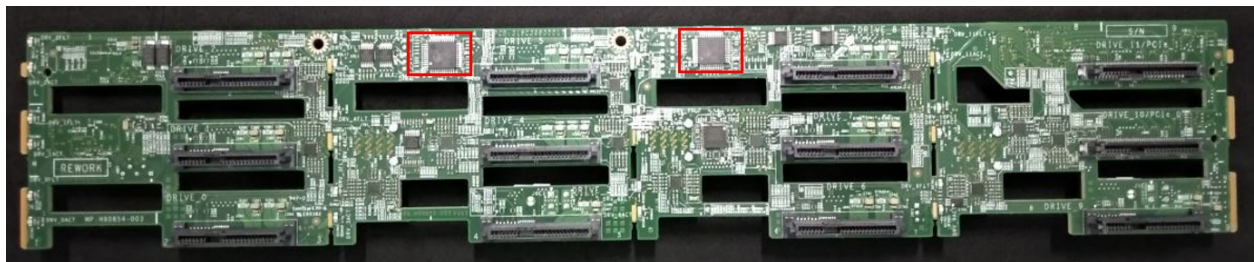
- QR code within the attention document K38867-001 from "Firmware Update Demo" to "BIOS Support Page"



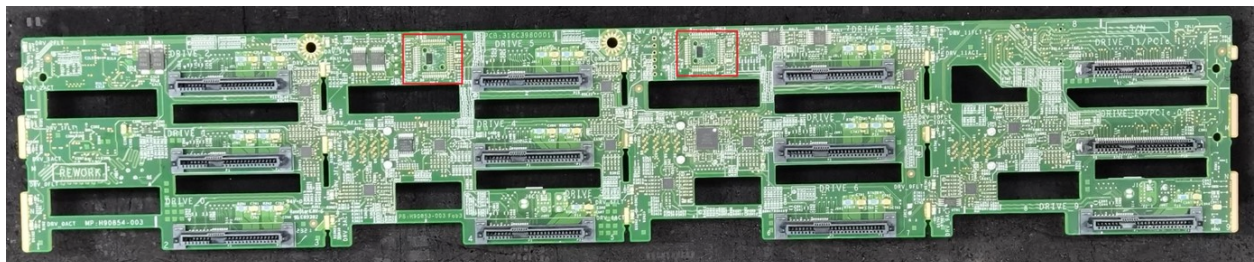
- Due to Integrated Circuit (IC) shortage from the supplier, a Programmable System-On-Chip (PSOC) used on the Hot Swap Backplanes needs to be replaced with an alternative component. The new component is identical in function than previous one but differs in form factor. For business continuity, demand fulfillment and to minimize customer impact, an interposer PCB supporting the new component was used. The new component has passed all functional and electrical validation test successfully.

For such reason, products listed in the "Products Affected" table could be delivered to customers with any of two different PBA codes of hot swap backplanes which can be identified as:  
H88392-351 or H88392-352

PBA Code Before - H88392-351



PBA Code After - H88392-352



## Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

## Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
Intel® Server System R2312WF0NPR, Single	R2312WF0NPR	986054	K40016-006	H87179-873 H87179-883	K40016-007	H87179-961 H87179-951 <a href="#">H88392-351</a> <a href="#">H88392-352</a>

## PCN Revision History:

Date of Revision:	Revision Number:	Reason:
October 26, 2021	00	Originally Published PCN
November 04, 2021	01	Correction of MM# for QDMS
<a href="#">December 13, 2021</a>	02	<a href="#">Updating Change Description and Products Affected table</a>



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## 118619-02

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

**Americas Contact:** [asmo.pcn@intel.com](mailto:asmo.pcn@intel.com)

**Asia Pacific/PRC Contact:** [apacgccb@intel.com](mailto:apacgccb@intel.com)

**Europe Email:** [eccb@intel.com](mailto:eccb@intel.com)

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